

Title (en)  
METHOD FOR THE PRODUCTION OF A THERMOELECTRIC MODULE

Title (de)  
VERFAHREN ZUR HERSTELLUNG EINES THERMOELEKTRISCHEN MODULS

Title (fr)  
PROCÉDÉ DE FABRICATION D'UN MODULE THERMOÉLECTRIQUE

Publication  
**EP 2684226 A2 20140115 (DE)**

Application  
**EP 12708537 A 20120307**

Priority  
• DE 102011005246 A 20110308  
• EP 2012053945 W 20120307

Abstract (en)  
[origin: WO2012120060A2] The invention relates to a thermoelectric module (2) comprising a metal housing element (4) and a ceramic layer (5) that is applied to the metal housing element (4). The thermoelectric module (2) further comprises an additional housing element (3) arranged on the side of the metal housing element (4) which is provided with the ceramic layer (5), the additional housing element (3) and the metal housing element (4) being joined to form a fluid-tight housing. The thermoelectric module (2) finally comprises at least one thermoelectrically active material (7, 8) which is arranged inside the fluid-tight housing.

IPC 8 full level  
**H01L 35/30** (2006.01); **F01N 3/023** (2006.01); **F01N 5/02** (2006.01); **F02M 25/07** (2006.01); **H01L 35/34** (2006.01)

CPC (source: EP US)  
**F01N 5/025** (2013.01 - EP US); **H10N 10/01** (2023.02 - EP US); **H10N 10/13** (2023.02 - EP US); **H10N 10/17** (2023.02 - EP US);  
**Y02T 10/12** (2013.01 - EP US)

Citation (search report)  
See references of WO 2012120060A2

Citation (examination)  
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• US 6274803 B1 20010814 - YOSHIOKA HIROKAZU [JP], et al  
• DE 102009013535 A1 20100923 - BEHR GMBH & CO KG [DE]  
• JP 2009117792 A 20090528 - UBE INDUSTRIES

Designated contracting state (EPC)  
AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

DOCDB simple family (publication)  
**DE 102011005246 A1 20120913**; CN 103460420 A 20131218; CN 103460420 B 20160608; DE 112012001140 A5 20140116;  
EP 2684226 A2 20140115; US 10217923 B2 20190226; US 2014060605 A1 20140306; WO 2012120060 A2 20120913;  
WO 2012120060 A3 20130510

DOCDB simple family (application)  
**DE 102011005246 A 20110308**; CN 201280012009 A 20120307; DE 112012001140 T 20120307; EP 12708537 A 20120307;  
EP 2012053945 W 20120307; US 201214003898 A 20120307